



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

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Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China





DZ4J082K0R

Silicon epitaxial planar type

For constant voltage / For surge absorption circuit

■ Features

- Excellent rising characteristics of zener current I_Z
- Low zener operating resistance R_Z
- Halogen-free / RoHS compliant
(EU RoHS / UL-94 V-0 / MSL:Level 1 compliant)

■ Marking Symbol: JJ

■ Basic Part Number :

Dual DZ2J082 (Parallel)

■ Packaging

Embossed type (Thermo-compression sealing) 3 000 pcs / reel (standard)

■ Absolute Maximum Ratings Ta = 25 °C

| Parameter | Symbol | Rating | Unit |
|---------------------------------------|------------------|-------------|------|
| Repetitive peak forward current | IFRM | 200 | mA |
| Total power dissipation ^{*1} | PT | 200 | mW |
| Electrostatic discharge ^{*2} | ESD | ±8 | kV |
| Junction temperature | T _j | 150 | °C |
| Operating ambient temperature | T _{opr} | -40 to +85 | °C |
| Storage temperature | T _{stg} | -55 to +150 | °C |

Note) *1: Mounted on glass epoxy print board. (45 mm x 45 mm x 1 mm)

Solder in (0.8 mm x 0.8 mm)

*2: Test method: IEC61000_4_2(C = 150 pF, R = 330 Ω, Contact discharge: 10 times)

■ Electrical Characteristics Ta = 25 °C ± 3 °C

| Parameter | Symbol | Conditions | Min | Typ | Max | Unit |
|--|-----------------|-------------------------|------|-----|------|-------|
| Forward voltage | V _F | I _F = 10 mA | | | 1.0 | V |
| Zener voltage ^{*1, *2} | V _Z | I _Z = 5 mA | 7.79 | | 8.61 | V |
| Zener operating resistance | R _Z | I _Z = 5 mA | | | 20 | Ω |
| Zener rise operating resistance | R _{ZK} | I _Z = 0.5 mA | | | 60 | Ω |
| Reverse current | I _R | V _R = 5 V | | | 0.1 | μA |
| Temperature coefficient of zener voltage ^{*3} | SZ | I _Z = 5 mA | | 4.7 | | mV/°C |

Note) 1. Measuring methods are based on JAPANESE INDUSTRIAL STANDARD JIS C 7031 Measuring methods for Diodes.

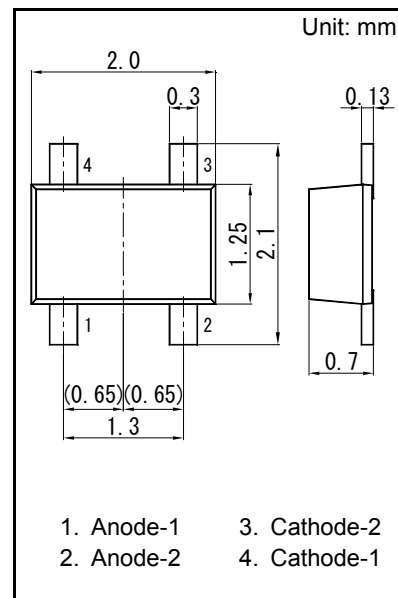
2. Absolute frequency of input and output is 5 MHz.

3. *1: The temperature must be controlled 25 °C for V_Z measurement.

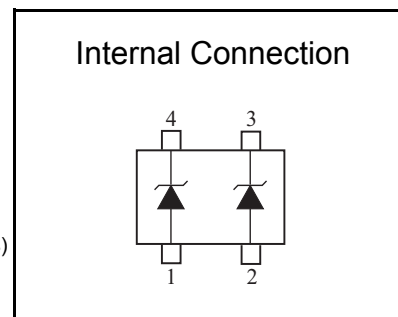
V_Z value measured at other temperature must be adjusted to V_Z (25 °C)

*2: V_Z guaranteed 20 ms after current flow.

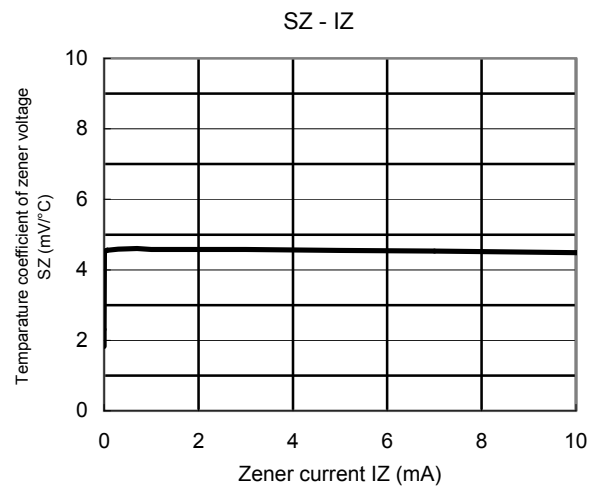
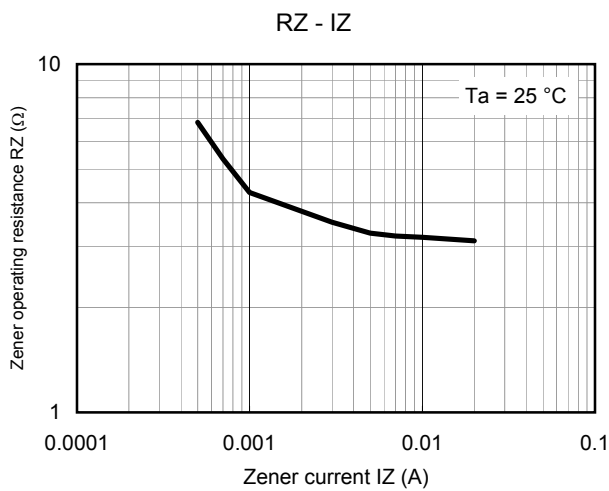
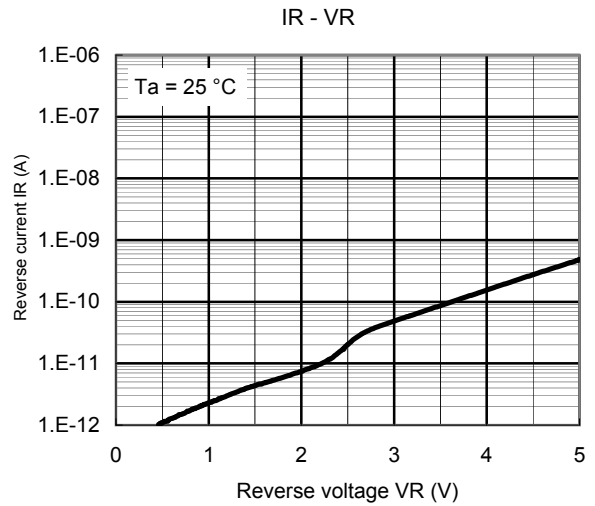
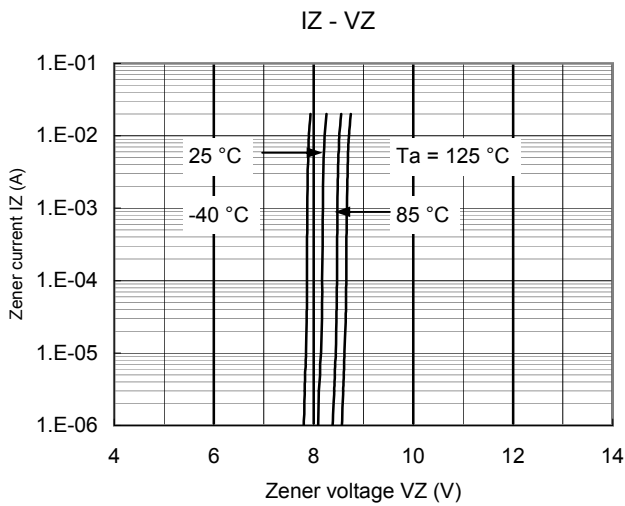
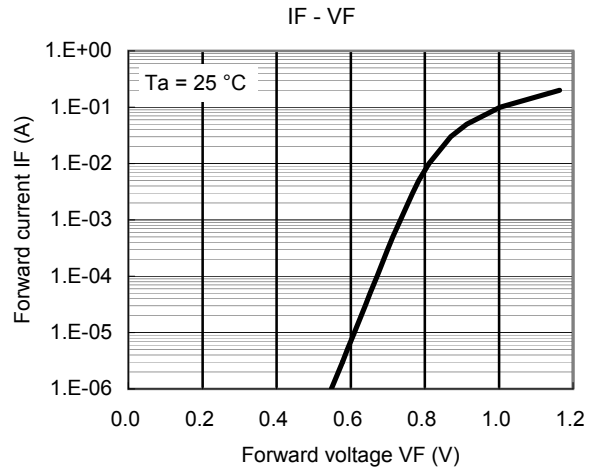
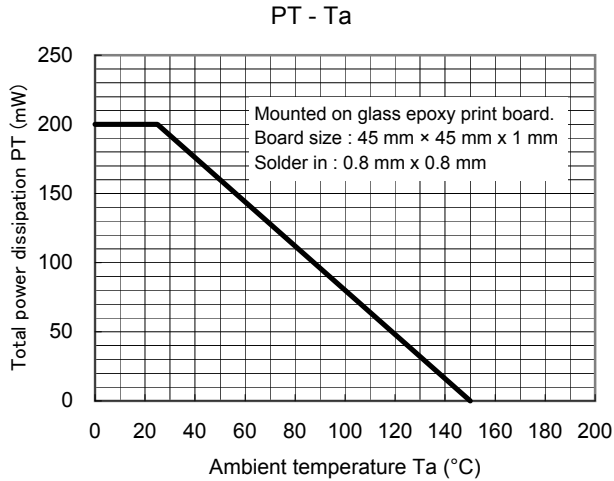
*3: T_j = 25 °C to 150 °C



| | |
|-----------|-------------|
| Panasonic | SMini4-F3-B |
| JEITA | SC-113BB |
| Code | — |

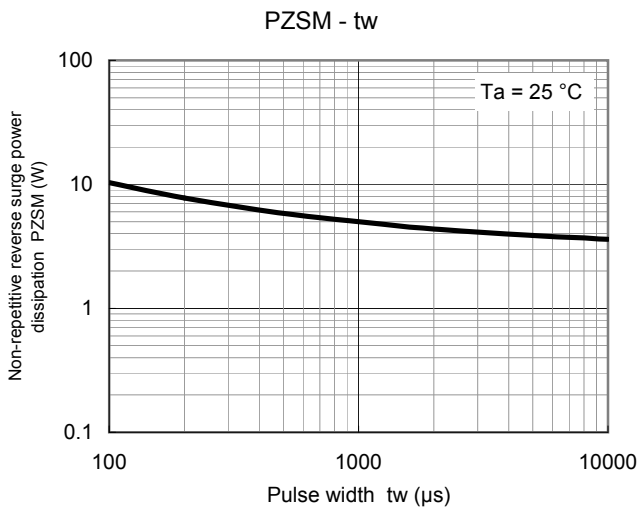
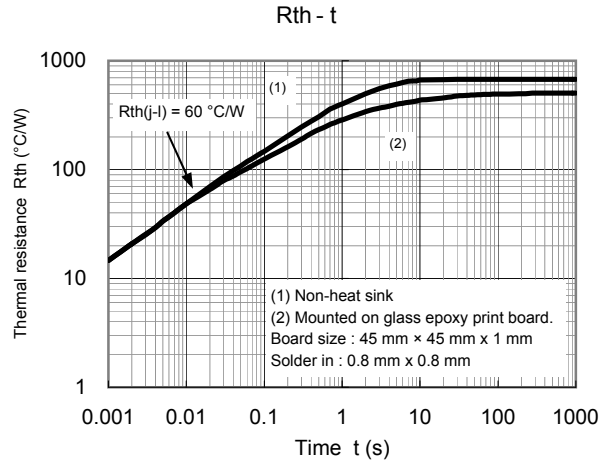
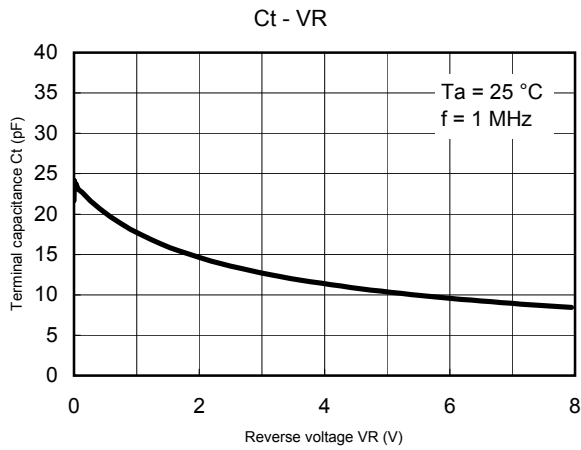


Technical Data (reference)



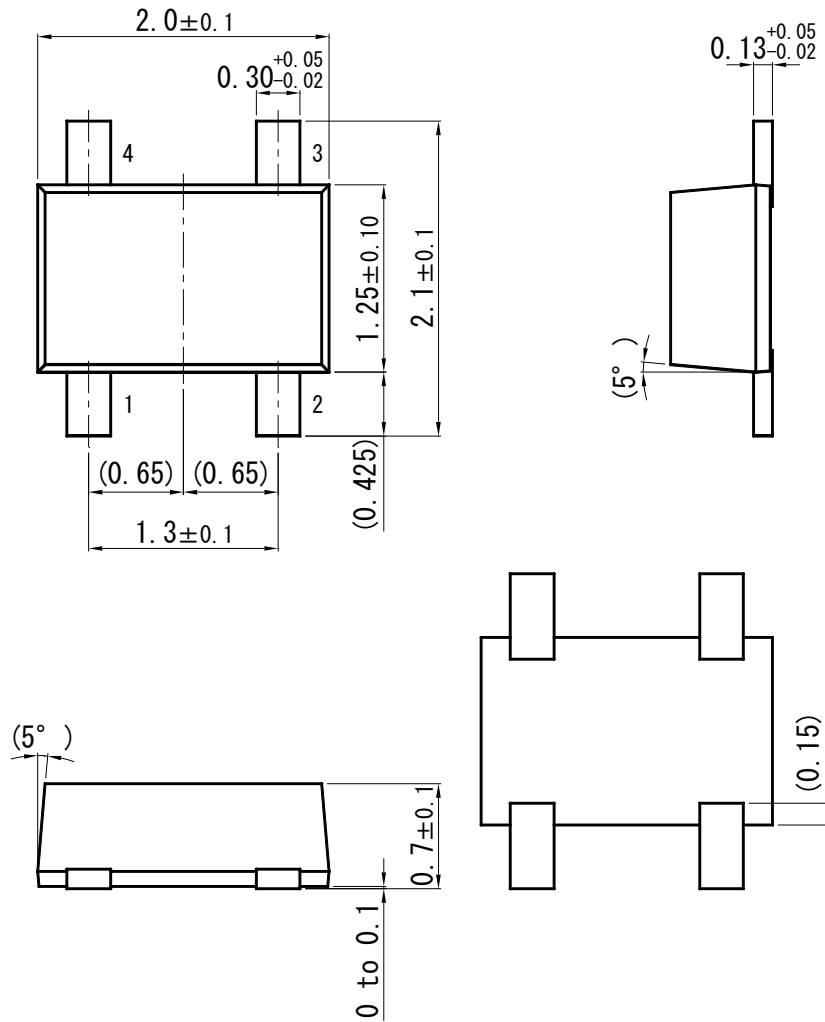


Technical Data (reference)

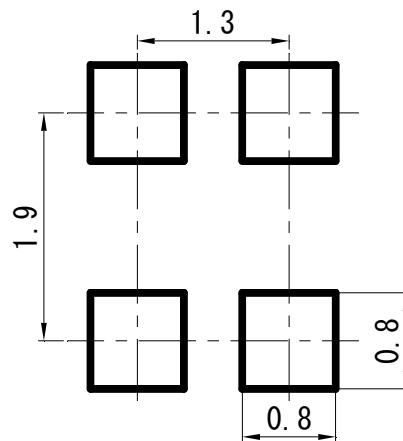


SMini4-F3-B

Unit: mm



■ Land Pattern (Reference) (Unit: mm)



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